

AMENDMENTS TO THE SPECIFICATION:

Add the following new paragraph between lines 17 and 18 of page 4:

It is to be noted that the terminal parts 30a in the terminal-forming area 3a for surface-mounting the device D1 and the terminal parts 30b in the terminal-forming area 3b for surface-mounting the device D2 are distributed differently on the surface 10 of the printed circuit board 1. Explained more in detail, according to this example, the device D1 is area-wise much smaller than the device D2 and the terminal-forming area 3a is much smaller than the terminal-forming area 3b. At least in part for this reason, the terminal parts 30a are more densely distributed within the terminal-forming area 3a than the terminal parts 30b within the terminal-forming area 3b. In other words, the terminal parts (30a, 30b, 30c and possibly others) are distributed over the surface 10 of the printed circuit board 1 not necessarily in a uniform manner but in general in a non-uniform manner, depending on the properties such as the size of the devices (D1, D2, D3 and possibly others) that may be mounted thereon and where they are to be mounted thereon.

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